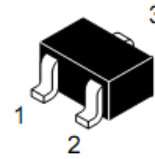


**WPM2015**

Single P-Channel, -20V, -2.4A, Power MOSFET

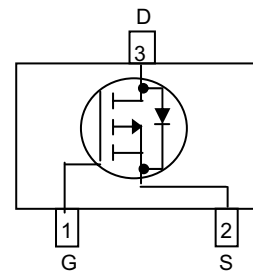
V <sub>DS</sub> (V)	R <sub>ds(on)</sub> (Ω)
-20	0.081@ V <sub>GS</sub> =-4.5V
	0.103@ V <sub>GS</sub> =-2.5V



**Descriptions**

The WPM2015 is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent R<sub>DS (ON)</sub> with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WPM2015 is Pb-free and Halogen-free.

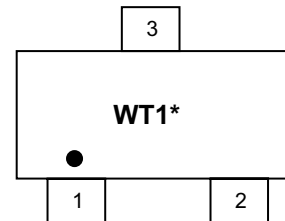
**SOT-23**



**Pin configuration (Top view)**

**Features**

- Trench Technology
- Supper high density cell design
- Excellent ON resistance for higher DC current
- Extremely Low Threshold Voltage
- Small package SOT-23



WT1= Device Code  
\* = Month (A~Z)

**Marking**

**Applications**

- Driver for Relay, Solenoid, Motor, LED etc.
- DC-DC converter circuit
- Power Switch
- Load Switch
- Charging

**Order information**

Device	Package	Shipping
WPM2015-3/TR	SOT-23	3000/Reel&Tape

**Absolute Maximum ratings**

Parameter		Symbol	10 S	Steady State	Unit
Drain-Source Voltage		$V_{DS}$	-20		V
Gate-Source Voltage		$V_{GS}$	$\pm 8$		
Continuous Drain Current <sup>a</sup>	$T_A=25^\circ\text{C}$	$I_D$	-2.4	-2.2	A
	$T_A=70^\circ\text{C}$		-1.9	-1.7	
Maximum Power Dissipation <sup>a</sup>	$T_A=25^\circ\text{C}$	$P_D$	0.9	0.8	W
	$T_A=70^\circ\text{C}$		0.5	0.5	
Continuous Drain Current <sup>b</sup>	$T_A=25^\circ\text{C}$	$I_D$	-2.2	-2.0	A
	$T_A=70^\circ\text{C}$		-1.7	-1.6	
Maximum Power Dissipation <sup>b</sup>	$T_A=25^\circ\text{C}$	$P_D$	0.7	0.6	W
	$T_A=70^\circ\text{C}$		0.5	0.4	
Pulsed Drain Current <sup>c</sup>		$I_{DM}$	-10		A
Operating Junction Temperature		$T_J$	150		$^\circ\text{C}$
Lead Temperature		$T_L$	260		$^\circ\text{C}$
Storage Temperature Range		$T_{stg}$	-55 to 150		$^\circ\text{C}$

**Thermal resistance ratings**

Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance <sup>a</sup>	$t \leq 10 \text{ s}$	$R_{\theta JA}$	105	135	$^\circ\text{C/W}$
	Steady State		120	155	
Junction-to-Ambient Thermal Resistance <sup>b</sup>	$t \leq 10 \text{ s}$	$R_{\theta JA}$	130	160	
	Steady State		145	190	
Junction-to-Case Thermal Resistance		$R_{\theta JC}$	60	75	

a Surface mounted on FR-4 Board using 1 square inch pad size, 1oz copper

b Surface mounted on FR-4 board using minimum pad size, 1oz copper

c Pulse width $<380\mu\text{s}$ , Duty Cycle $<2\%$

d Maximum junction temperature  $T_J=150^\circ\text{C}$ .

## Electronics Characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-to-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250uA	-20			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V			-1	uA
Gate-to-source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±8V			±100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = -250uA	-0.40	-0.62	-0.81	V
Drain-to-source On-resistance <sup>b, c</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -2.7A		81	110	mΩ
		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -2.2A		103	150	
<b>CAPACITANCES, CHARGES</b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1.0 MHz, V <sub>DS</sub> = -10 V		534		pF
Output Capacitance	C <sub>OSS</sub>			62		
Reverse Transfer Capacitance	C <sub>RSS</sub>			54		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = -4.5 V, V <sub>DS</sub> = -10 V, I <sub>D</sub> = -2.7A		7.3		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>			0.5		
Gate-to-Source Charge	Q <sub>GS</sub>			1.25		
Gate-to-Drain Charge	Q <sub>GD</sub>			1.15		
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	td(ON)	V <sub>GS</sub> = -4.5 V, V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1.2A, R <sub>G</sub> = 6 Ω		8.0		ns
Rise Time	tr			6.4		
Turn-Off Delay Time	td(OFF)			41.0		
Fall Time	tf			7.0		
<b>BODY DIODE CHARACTERISTICS</b>						
Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = -0.9A		-0.74	-1.5	V